

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

# **Product image**























High-temperature-resistant, straight, open pin header. Packed in box or tape. On tape and with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

## General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.08 mm, Number of poles: 8, 270°, Solder pin length (I): 3.2 mm, tinned, black, Box
Order No.	<u>1877550000</u>
Туре	SL-SMT 5.08HC/08/270GL 3.2SN BK BX
GTIN (EAN)	4032248468171
Qty.	50 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Вох

Creation date March 26, 2021 2:25:46 AM CET



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# **Technical data**

## **Dimensions and weights**

Depth	12 mm	Depth (inches)	0.472 inch
Height	11.7 mm	Height (inches)	0.461 inch
Height of lowest version	8.5 mm	Net weight	4.18 g
Width	43.84 mm	Width (inches)	1.726 inch

## **System specifications**

Product family	OMNIMATE Signal - series	Type of connection	
Floductianily	BL/SL 5.08	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5.08 mm
Pitch in inches (P)	0.2 inch	Outgoing elbow	270°
Number of poles	8	Number of solder pins per pole	1
Solder pin length (I)	3.2 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerance (I	D)+ 0,1 mm	L1 in mm	35.56 mm
L1 in inches	1.4 inch	Number of rows	1
Pin series quantity	1	Touch-safe protection acc. to DIN VDE 57 106	finger-safe plugged/ back- of-hand-safe unplugged
Touch-safe protection acc. to DIN VDE	IP20 plugged/ IP10	Volume resistance	
0470	unplugged		≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	9 N
Pulling force/pole, max.	7 N		

#### **Material data**

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuMg
Contact surface		Layer structure of solder connection	13 μm Ni / 24 μm Sn
	tinned		matt
Layer structure of plug contact	13 μm Ni / 24 μm Sn	Storage temperature, min.	
	matt		-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

## Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		



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40 mm

165 mm

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#### Rated data acc. to CSA

Packaging

VPE width

nstitute (CSA)	<b>(1)</b>	Certificate No. (CSA)	
			200039-1176845
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	18.5 A	Rated current (Use group D / CSA)	18.5 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		
Rated data acc. to UL 1059			
potituto (LID)		Cortificate No. (LID)	
Institute (UR)	<b>71</b> °	Certificate No. (UR)	E60693
	<b>300 V</b>	Certificate No. (UR)  Rated voltage (Use group D / UL 1059)	
Institute (UR)  Rated voltage (Use group B / UL 1059) Rated current (Use group B / UL 1059)			300 V

Classifications			
ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02

VPE length

VPE height

Classifications						
ETIM 6.0	EC002637	ETIM 7.0	EC002637			
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02			
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01			
Important note						
IPC conformity	standards and norms an	• •	rered according international recognized the data sheet resp. fulfill decorative properties oducts can be evaluated on request.			
Notes	Gold-plated contact su	Gold-plated contact surfaces on request				
	Rated current related to rated cross-section & min. No. of poles.					
	Diameter of solder eye	elet D = 1.4+0.1mm				
	Solder eyelet diamete	r D = 1.5 + 0.1 mm, from 9 poles				
	• P on drawing = pitch					
	•	o the component itself. Clearance and c lance with the relevant application stand	reepage distances to other components are to ards.			
	Long term storage of	the product with average temperature of	50 °C and average humidity 70%, 36 months			

Box

65 mm



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# **Technical data**

#### **Approvals**

Approvals



ROHS	Conform
UL File Number Search	E60693

#### **Downloads**

Approval/Certificate/Document of	
Conformity	Declaration of the Manufacturer
Engineering Data	STEP



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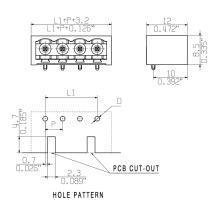
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# **Drawings**

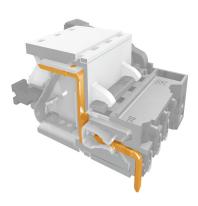
# **Product image**



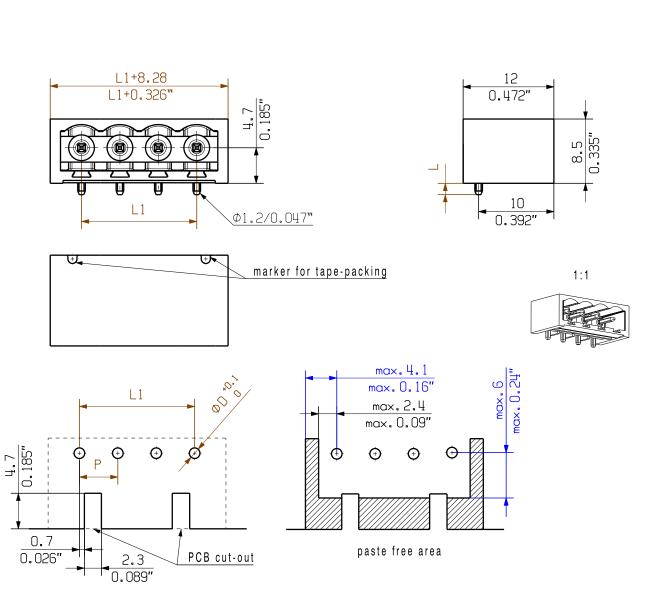
# **Dimensional drawing**



# **Product benefits**



Safe power transmission Proven properties



For the mounting of PCBs, it should be noted that the rated data given in the catalogue relates only to the connection elements. The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to VDE 0110. The current-carrying capacity and pitch tolerance is to

be determined according to DIN IEC 326 part 3 very fine.

hole pattern

1,5 0
-0.3
3,2 0.1
-0.3
pin lenght L tolerance

Weidmüller connectors are tested to the DIN VDE 0627 standard, and are valid for its field of application. Provided that the connectors are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.

D = 1.4/0.055" (reflow soldering) recommendation for automatic assembly (1.4mm for n = 2...8)

Approved

P = Pitch

Supersedes: .

shown: SL-SMT 5.08HC/04/270GL

2 n	5,08 L1 [mm]	0,200 L1 [Inch]	tolerance L1
3	10,16	0,400	
4	15,24	0,600	
5	20,32	0,800	±0.1
6	25,40	1,000	
7	30,48	1,200	
8	35,56	1,400	

SHOWH. 3L-3WI 3.00HG/04/27	UGL				"   "	լատոյլեւլ	incinj id	nerance LT
GENERAL TOLERANCE:						Cat.	n o . : .	
DIN ISO 2768-m	91033/4 03.02.17 HE	-	We	eidmüller	<b>%</b>	3 Drawing no.	3789	9 17 Issue no.
V	Modifi	cation				Sheet 01	of	06 sheets
		Date	Name					
	Drawn	23.03.2004	DOMRATH_M	SL-SMT	5.081	HC//	270	

Drawn 23.03.2004 DOMRATH\_M
Responsible HERTEL\_S
Scale: 2/1 Checked 06.02.2017 HELIS\_MA

Branch Stiff Leiste Male HEADER

LANG T

Product file: SL-SMT 5.08

7313



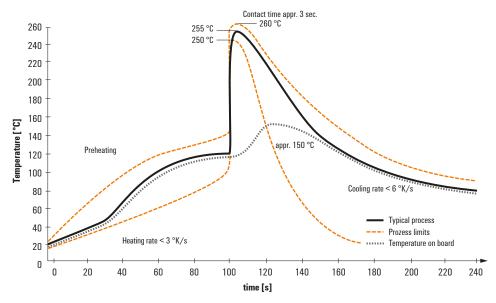
# Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

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Fon: +49 5231 14-0 Fax: +49 5231 14-292083 www.weidmueller.com

## Single Wave:



#### **Double Wave:**



## Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

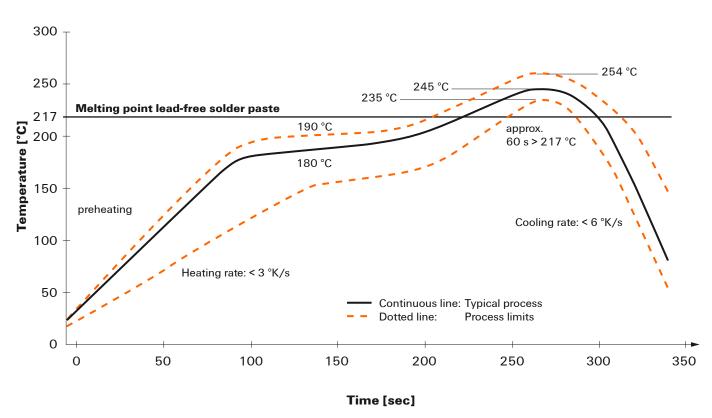


# Recommended reflow soldering profile

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## **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- · Time for cooling
- · Maximum heating rate
- · Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.